

Absolute Maximum Ratings

IN to GND -0.3V to +45V
 OUT1, OUT2, OUT3, DIM1, DIM2,
 DIM3 to GND -0.3V to ($V_{IN} + 0.3V$)
 REG, LGC, LEDGOOD to GND -0.3V to +6V
 CS1, CS2, CS3 to GND -0.3V to +0.5V
 OUT1, OUT2, OUT3 Short Circuited
 to GND Duration ($V_{IN} + 16V$) 60min
 Maximum Current into Any Pin
 (except IN, OUT1, OUT2, OUT3) $\pm 20mA$

Continuous Power Dissipation ($T_A = +70^\circ C$)
 16-Pin TQFN 5mm x 5mm 2666mW
 (derate 33.3mW/ $^\circ C$ above $+70^\circ C$)
 16-Pin TSSOP (derate 26.1mW/ $^\circ C$ above $+70^\circ C$) 2088.8mW
 Operating Temperature Range $-40^\circ C$ to $+125^\circ C$
 Junction Temperature $+150^\circ C$
 Storage Temperature Range $-65^\circ C$ to $+150^\circ C$
 Lead Temperature (soldering, 10s) $+300^\circ C$

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Electrical Characteristics

($V_{IN} = 12V$, $C_{REG} = 0.1\mu F$, $I_{REG} = 0$, $C_{LGC} = 15nF$, $V_{DIM1} = V_{DIM2} = V_{DIM3} = 3.4V$, $R_{CS_} = 2.85\Omega$ from $CS_$ to GND, $T_J = T_A = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Supply Voltage Range	V_{IN}		5.5		40	V
Undervoltage Lockout	UVLO	V_{IN} rising	4.4	4.9	5.4	V
		V_{IN} falling	4.0	4.6	5.2	
Ground Current	I_G	$I_{OUT1} = I_{OUT2} = I_{OUT3} = 70mA$		1.5	3	mA
Guaranteed Output Current	I_{OUT}		100			mA
LED Current-Sense Accuracy		$5mA \leq I_{OUT_} \leq 70mA$			5	%
Dropout Voltage (Note 2)	ΔVDO	$I_{OUT_} = 70mA$, $6.5V \leq V_{IN} \leq 40V$		0.3	0.7	V
		$I_{OUT_} = 70mA$, $5.5V \leq V_{IN} \leq 6.5V$		0.3	0.8	
Output Current Slew Rate				8		mA/ μs
Short-Circuit Current		$V_{OUT_} = 0V$		180		mA
LEDGOOD						
LEDGOOD Output Logic Low	V_{OL}	$I_{SINK} = 2mA$			0.4	V
LGC Pullup Resistor			65	100	135	k Ω
LGC Input Upper Threshold	V_{UTH}			2.53		V
LGC Input Lower Threshold	V_{LTH}			0.8		V
LGC Pulldown Current		$V_{LGC} > V_{UTH}$		20		mA
LGC Clock Period		$C_{LGC} = 15nF$	0.77	1.5	2.3	ms
DIMMING INPUT (DIM1, DIM2, DIM3)						
DIM_ Logic-Input Bias Current	$I_{DIM_}$		-0.1		+0.1	μA
DIM_ Input-Voltage High			2.4		V_{IN}	V
DIM_ Input-Voltage Low					0.6	V
DIM_ Frequency			0		3	kHz

Electrical Characteristics (continued)

($V_{IN} = 12V$, $C_{REG} = 0.1\mu F$, $I_{REG} = 0$, $C_{LGC} = 15nF$, $V_{DIM1} = V_{DIM2} = V_{DIM3} = 3.4V$, $R_{CS_} = 2.85\Omega$ from $CS_$ to GND, $T_J = T_A = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.) (Note 1)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
OUTPUTS (OUT1, OUT2, OUT3) (Note 3)						
Turn-On Time		DIM_ rising edge to 90% of OUT_ current		12	28	μs
Turn-Off Time		DIM_ falling edge to 10% of OUT_ current		8	18	μs
Output Current Rise Time		10% to 90%		7	18	μs
Output Current Fall Time		90% to 10%		6	15	μs
CURRENT SENSE						
Regulated $CS_$ Voltage	$V_{CS_}$	$5mA \leq I_{OUT_} \leq 70mA$	193	203	213	mV
Input Current ($CS1$, $CS2$, $CS3$)		Current out of $CS_$			+1.2	μA
OVERTEMPERATURE PROTECTION (Note 4)						
Thermal Shutdown Temperature				155		$^\circ C$
Thermal Shutdown Hysteresis				23		$^\circ C$
3.4V REGULATOR (REG)						
Output Voltage	V_{REG}		3.275	3.41	3.547	V
		$0 \leq I_{REG} \leq 4mA$	3.221	3.38	3.547	
REG Short-Circuit Current		$V_{REG} = 0V$		13		mA

Note 1: All devices 100% production tested at $T_J = +25^\circ C$. Limits over the operating temperature range are guaranteed by design.

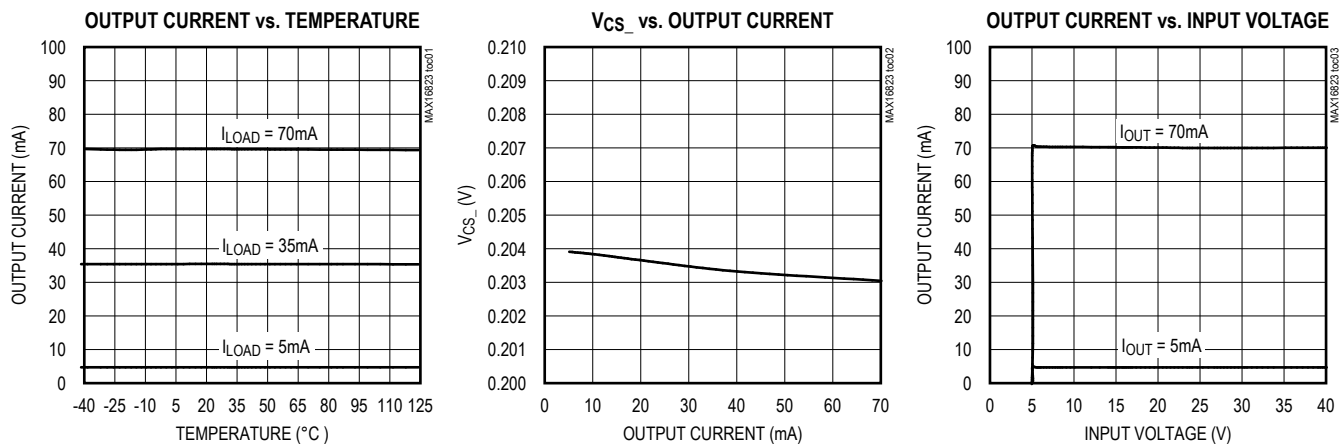
Note 2: Dropout is measured as follows: Connect a resistor from $OUT_$ to $CS_$. Connect $R_{CS_} = 2.85\Omega$ from $CS_$ to GND. Set $V_{IN} = V_{OUT} + 3V$ (record V_{OUT} as V_{OUTA}). Reduce V_{IN} until $V_{OUT} = 0.97 \times V_{OUTA}$ (record as V_{INB} and V_{OUTB}). $VDO = V_{INB} - V_{OUTB}$.

Note 3: Output current rise and fall times are measured with a 62Ω series resistor from $OUT_$ to $CS_$.

Note 4: Overtemperature protection does not function if the output of the 3.4V reference (REG) is shorted to ground.

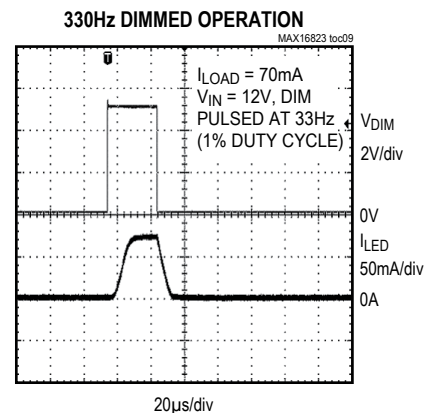
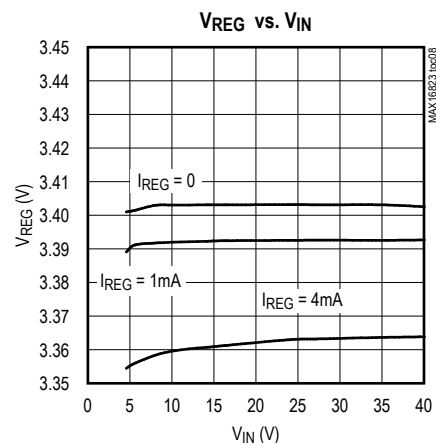
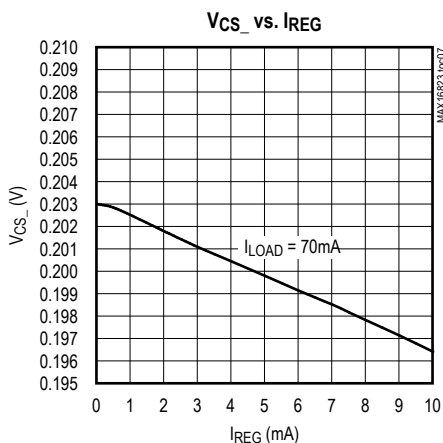
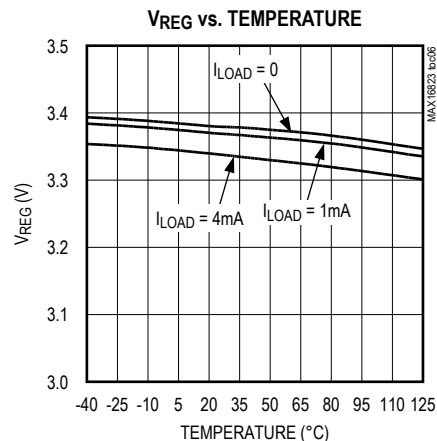
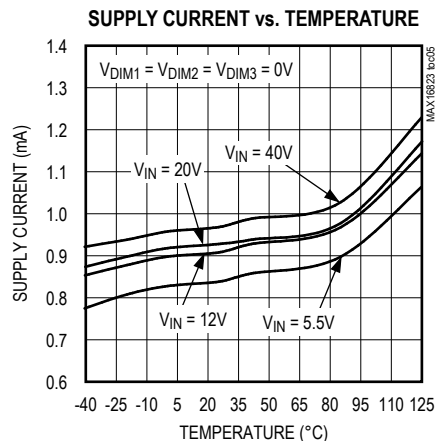
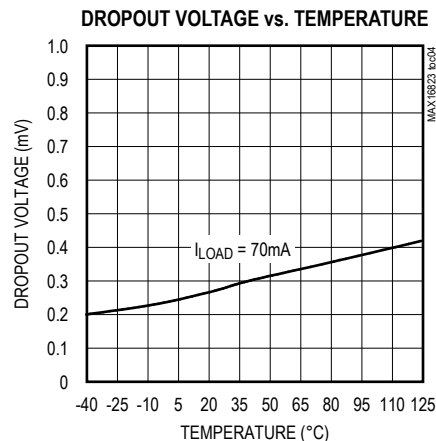
Typical Operating Characteristics

($V_{IN} = 12V$, $C_{REG} = 0.1\mu F$, $I_{REG} = 0$, $V_{LGC} =$ unconnected, connect $R_{CS_} = 2.85\Omega$ from $CS_$ to GND. Connect $OUT_$ to $CS_$ through a resistor, $T_J = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)

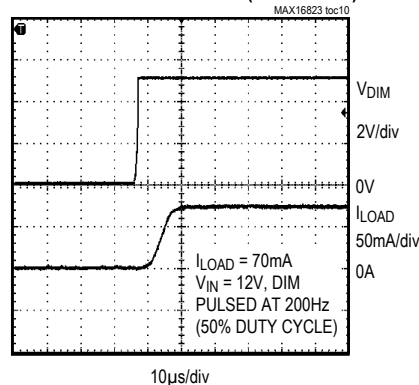


Typical Operating Characteristics (continued)

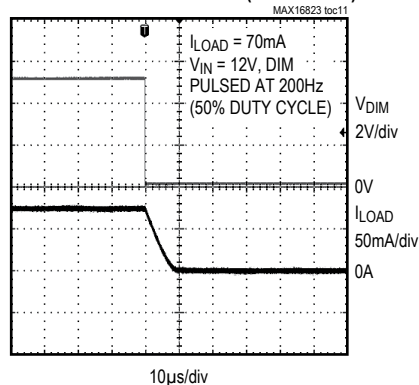
($V_{IN} = 12V$, $C_{REG} = 0.1\mu F$, $I_{REG} = 0$, $V_{LGC} =$ unconnected, connect $R_{CS_} = 2.85\Omega$ from $CS_$ to GND. Connect $OUT_$ to $CS_$ through a resistor, $T_J = -40^\circ C$ to $+125^\circ C$, unless otherwise noted. Typical values are at $T_A = +25^\circ C$.)



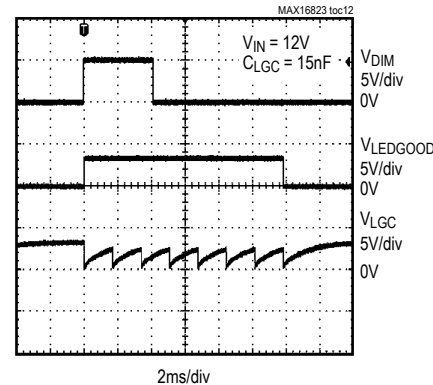
200Hz DIMMED OPERATION (EXPANDED)



200Hz DIMMED OPERATION (EXPANDED)



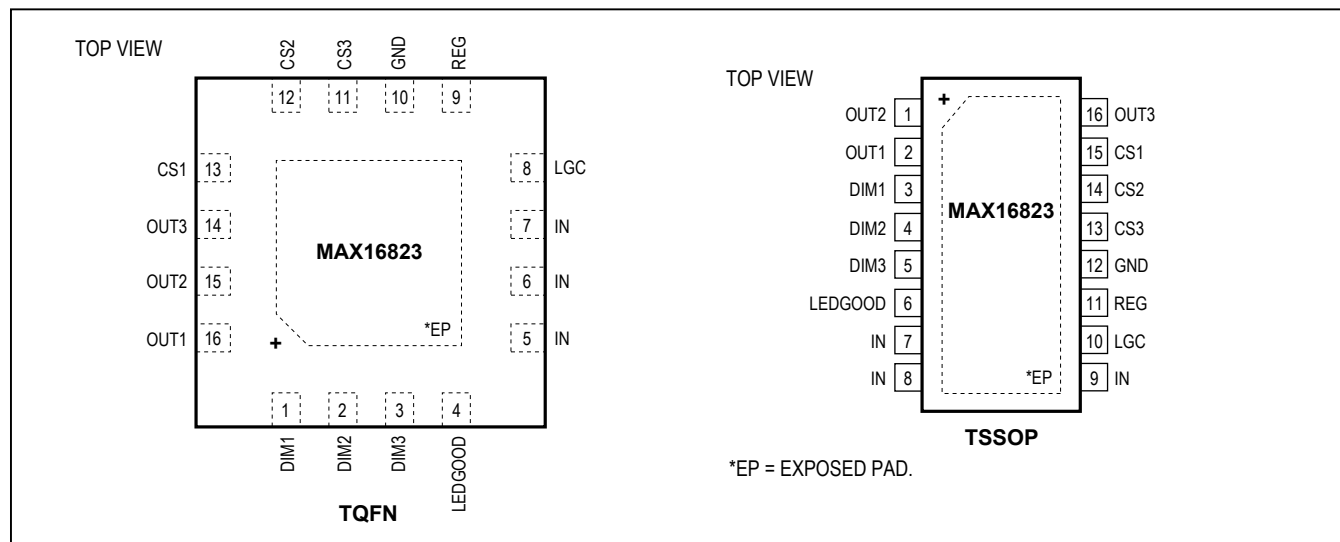
LEDGOOD RESPONSE TIMES



MAX16823

High-Voltage, 3-Channel Linear High-Brightness LED Driver with Open LED Detection

Pin Configurations



Pin Description

PIN		NAME	FUNCTION
TQFN	TSSOP		
1	3	DIM1	Dimming Input 1. DIM1 is a low-frequency dimming input for channel 1. A logic-low turns off OUT1 and a logic-high turns on OUT1.
2	4	DIM2	Dimming Input 2. DIM2 is a low-frequency dimming input for channel 2. A logic-low turns off OUT2 and a logic-high turns on OUT2.
3	5	DIM3	Dimming Input 3. DIM3 is a low-frequency dimming input for channel 3. A logic-low turns off OUT3 and a logic-high turns on OUT3.
4	6	LEDGOOD	Open LED Output. LEDGOOD is an open-drain output. A logic-high indicates the LED connection is good in all three channels. A logic-low indicates an open LED connection. See the <i>LEDGOOD</i> section.
5, 6, 7	7, 8, 9	IN	Positive Input Supply. Bypass with a 0.1μF (min) capacitor to GND. Connect all IN pins together.
8	10	LGC	LED Detection-Timing Setting. Connect a capacitor from LGC to ground to set the delay time for LEDGOOD.
9	11	REG	3.4V Voltage Regulator. Connect a 0.1μF capacitor from REG to GND.
10	12	GND	Ground
11	13	CS3	Channel 3 Sense Amplifier Positive Input. Connect the current-sense resistor between CS3 and GND to program the output current level for channel 3.
12	14	CS2	Channel 2 Sense Amplifier Positive Input. Connect the current-sense resistor between CS2 and GND to program the output current level for channel 2.
13	15	CS1	Channel 1 Sense Amplifier Positive Input. Connect the current-sense resistor between CS1 and GND to program the output current level for channel 1.
14	16	OUT3	Current Regulator Output 3
15	1	OUT2	Current Regulator Output 2
16	2	OUT1	Current Regulator Output 1
—	—	EP	Exposed Pad. Connect EP to a large-area ground plane for effective power dissipation. Do not use as the IC ground connection.

Detailed Description of Hardware

The MAX16823 three-channel current regulator operates from a 5.5V to 40V input voltage range and delivers up to 100mA per channel to one or more strings of HB LEDs. The output currents are programmable using external current-sense resistors in series with the LEDs. Three DIM inputs allow a wide range of independent pulsed dimming in addition to providing the on and off control of the outputs. The MAX16823 offers an LED-GOOD output that indicates an open-circuit condition when one or more LED channels are open.

Integrated pass elements minimize external components while providing $\pm 5\%$ output current accuracy. Additional features include a 3.4V ($\pm 5\%$) voltage regulator with 4mA output current capability, short-circuit and thermal protection.

The MAX16823 uses a feedback loop to linearly control the current from each output. The voltage across each sense resistor is compared to a fixed reference voltage and the error is amplified to drive the internal power pass device for a particular channel. See the [Block Diagram](#). The regulation point is factory-set at 203mV. The regulated current is adjusted by the value of $R_{CS_}$.

The MAX16823 is a constant-current LED driver internally optimized for driving the impedance range expected from one or more HB LEDs.

3.4V Regulator (REG)

The MAX16823 includes a fixed 3.4V voltage regulator that delivers up to 4mA of load current for auxiliary applications throughout the 5.5V to 40V input voltage range. Connect a 0.1 μ F compensation capacitor from REG to ground. Shorting REG to ground disables the thermal shutdown.

Thermal Protection

The MAX16823 enters a thermal-shutdown mode in the event of overheating. This typically occurs in overload or output short-circuit conditions. When the junction temperature exceeds $T_J = +155^\circ\text{C}$, the internal thermal protection circuitry turns off the series pass elements. The MAX16823 recovers from thermal-shutdown mode once the junction temperature drops by 23°C . The part will therefore protect itself by low-frequency thermal cycling in the event of a short-circuit or overload condition.

Applications Information

Programming the LED Current

The MAX16823 uses sense resistors to set the output current for each channel. To set the LED current for a particular channel, connect a sense resistor across the corresponding current-sense input ($CS_$) and GND. For optimal accuracy, connect the low-side of the current-sense resistors to the IC's ground pin with short traces. The value needed for the sense resistor for a given current can be calculated with the equation below:

$$R_{CS_}(\Omega) = \frac{V_{CS_}(V)}{I_{OUT_}(A)}$$

where $V_{CS_}$ is 203mV and $I_{OUT_}$ is the desired LED current (I_{LED}).

Input-Voltage Considerations

For proper operation, the minimum input voltage must always be:

$$V_{IN(MIN)} \geq V_{CS_}(MAX) + V_{FT}(MAX) + V_{DO}(MAX)$$

where $V_{FT}(MAX)$ is the total forward voltage of all series-connected LEDs. The minimum operating voltage of the device is 5.5V.

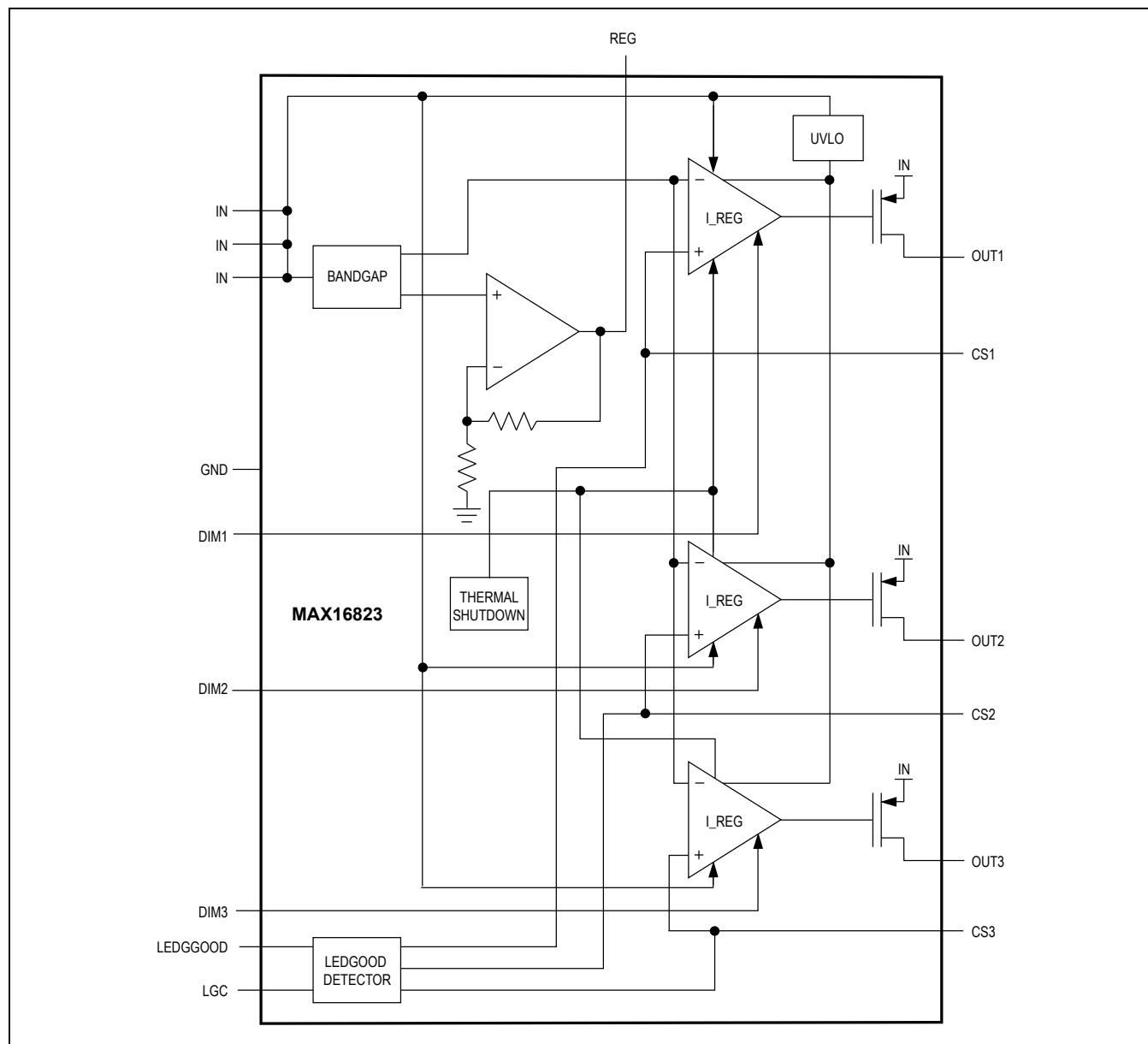
LEDGOOD

The MAX16823 features an active-low, open-drain LEDGOOD output that goes low either when one or more LED channels are open or when a signal at any of the dimming inputs remains low for a period greater than the programmed LEDGOOD delay time t_{DELAY} . Program t_{DELAY} with a capacitor connected between LGC and ground. The LEDGOOD output goes low after the programmed delay period t_{DELAY} has elapsed. Use the following formula to set the delay period:

$$t_{CK} = 112,000 \times C_{LGC} (F) \\ 4 \times t_{CK} < t_{DELAY} < 6 \times t_{CK}$$

where C_{LGC} is the capacitor connected between LGC and ground. The LEDGOOD output goes low during the thermal shutdown. The minimum recommended value of the capacitance that can be used on the LGC pin is 100pF.

Block Diagram



Pulse-Dimming Inputs (DIM_)

The MAX16823 features pulsed or chopped-current dimming inputs (DIM_) to chop the LED current and to adjust the brightness. DIM_ also serves as an active-high enable input. A logic-low at DIM_ turns off OUT_ and a logic-high turns on OUT_. If the signal at DIM stays low more than the programmed LEDGOOD delay time, LEDGOOD goes low (Figure 1).

Two Brightness Levels for TAIL/STOP Lights

Figure 2 shows the PWM dimming operation for the MAX16823 with an ICM7555 timer. The ICM7555 provides an adjustable duty cycle using two external resistors and a capacitor. In TAIL operation, the output of the ICM7555 feeds into DIM and lights up the LEDs. The LED's brightness depends on the duty cycle of the ICM7555. When V_{STOP} is present, DIM is pulled up to V_{STOP} . The

PWM dimming operation is disabled and the LEDs light up to full brightness. See the ICM7555 data sheet for formulas to calculate the dimming frequency and the duty cycle.

Outputs Latch-Off

Figure 3 shows a circuit with DIM1, DIM2, DIM3, and LEDGOOD connected through a resistor to V_{REG} . This circuit is useful for applications that require all outputs to latch off when one of the LEDs opens. The MAX16823 resumes current regulation again through power cycling, once the fault condition is removed.

Other Applications

The application circuit in Figure 4 implements a two-level brightness current for TAIL/STOP lights. In TAIL operation, Q1 is off and R_{CS1} sets the output current. In STOP operation, Q1 turns on and the output current is set by a parallel combination of R_{CS1} and R2.

Figure 5 shows an application circuit with the MAX16823 using a single BJT to provide high output current. For proper operation:

$$V_{IN(MIN)} > V_{BE(MAX)} + V_{FT(MAX)} + V_{CS_} + V_{DO(MAX)}$$

For minimized dropout, the LEDs can be placed in the collector.

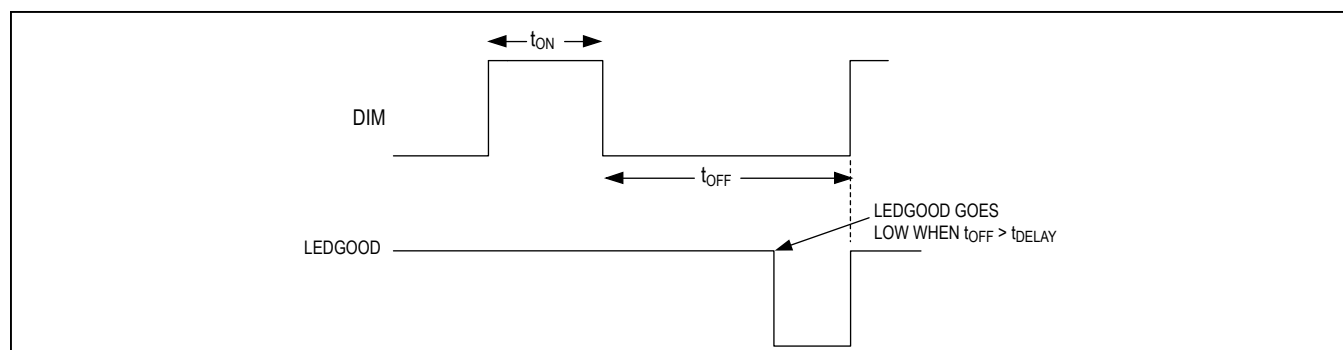


Figure 1. LEDGOOD Timing Delay

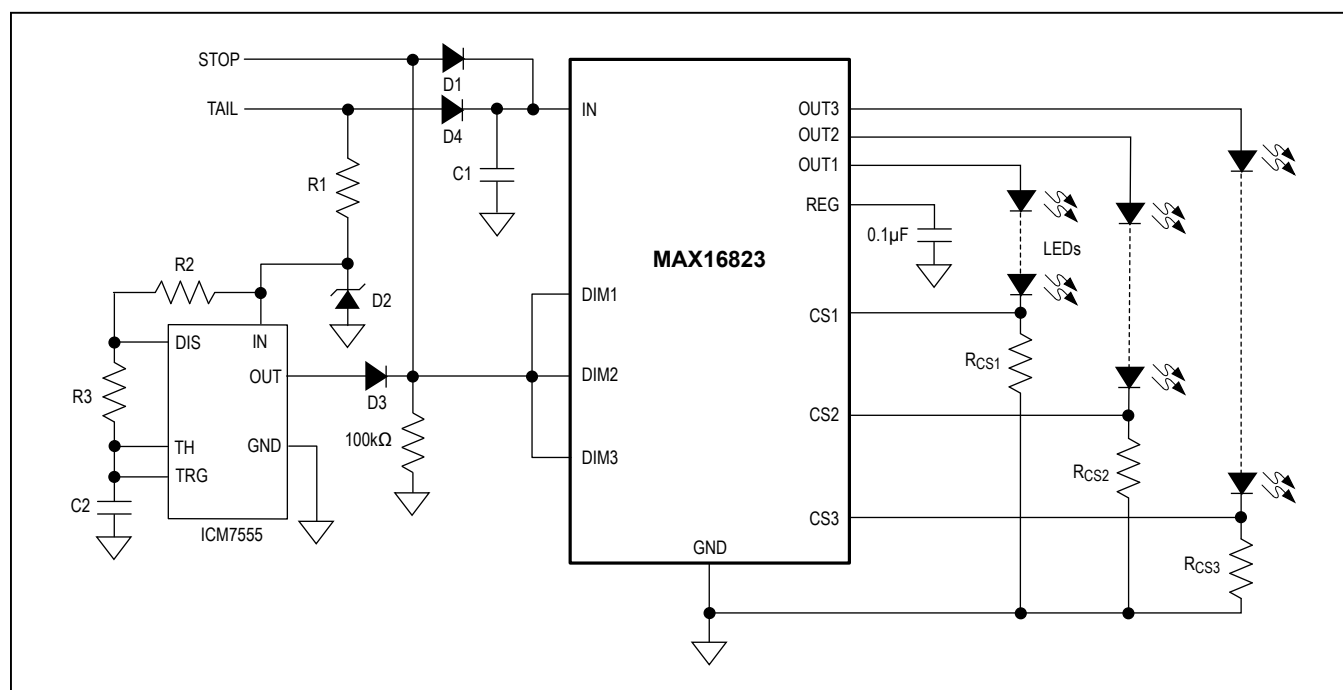


Figure 2. PWM Dimming Operation with ICM7555

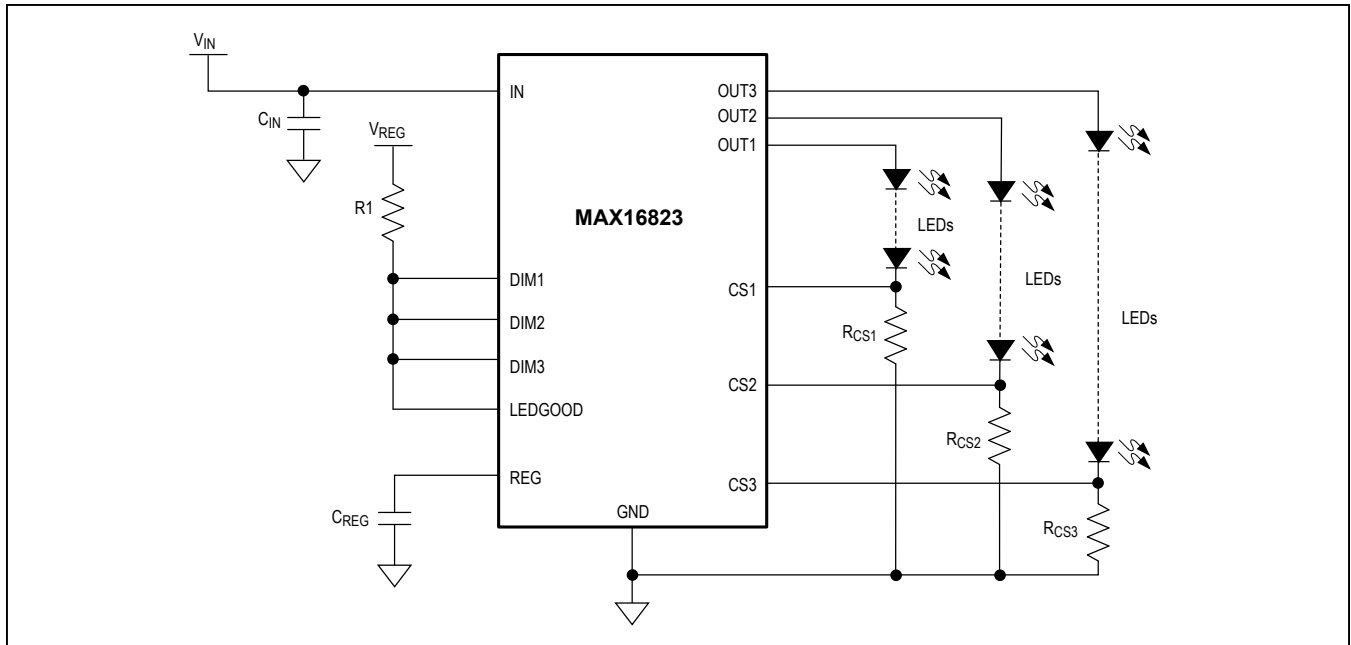


Figure 3. Output_Latch-Off

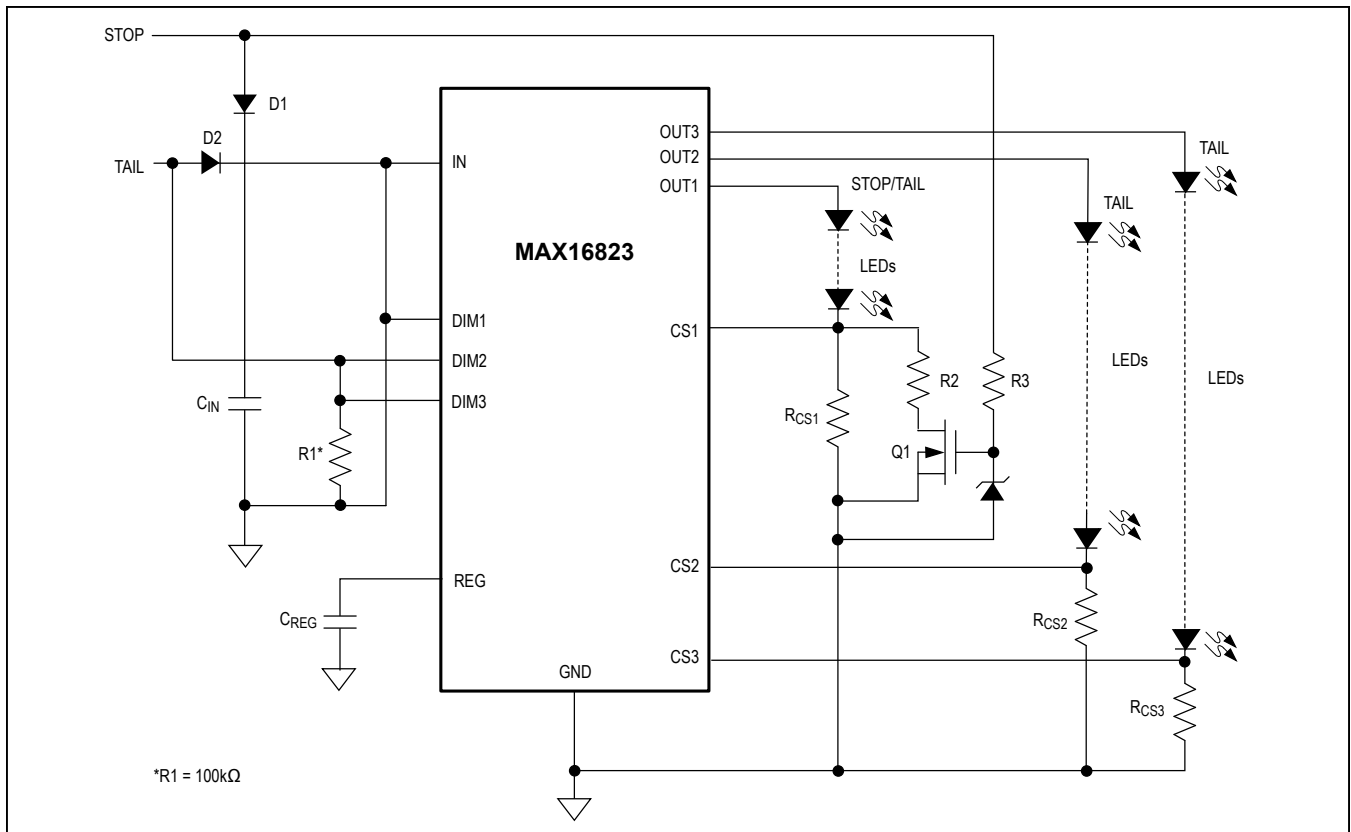


Figure 4. Two-Brightness Level with Current Level Switch for TAIL/STOP Lights

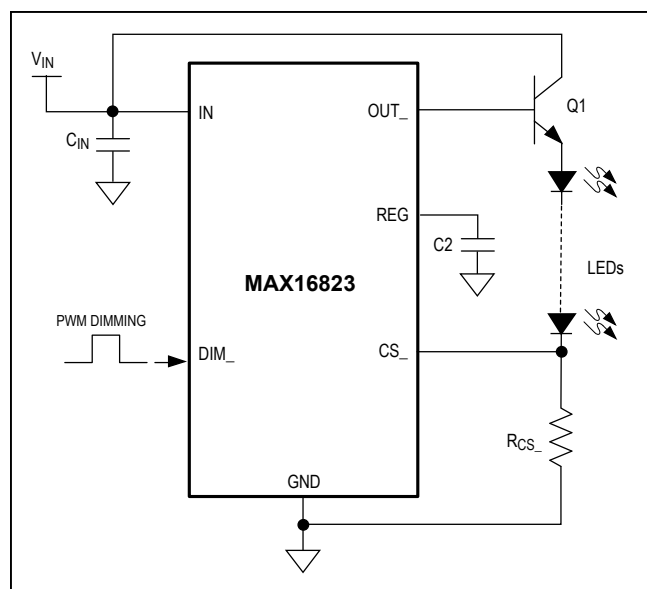


Figure 5. Increased LED Current (Ampere Range) with a Single BJT

Preload Current

Figure 6 shows the MAX16823 with a preload circuit. In the circuit, the BJT, $R_{PRELOAD}$, and REG generate a preset load current. The preset load current I_{PRESET} is determined with the following formula:

$$I_{PRESET} = \frac{V_{REG} - 0.7V}{R_{PRELOAD}}$$

This circuit is used with older body controllers that monitor minimum RCL current to detect failures.

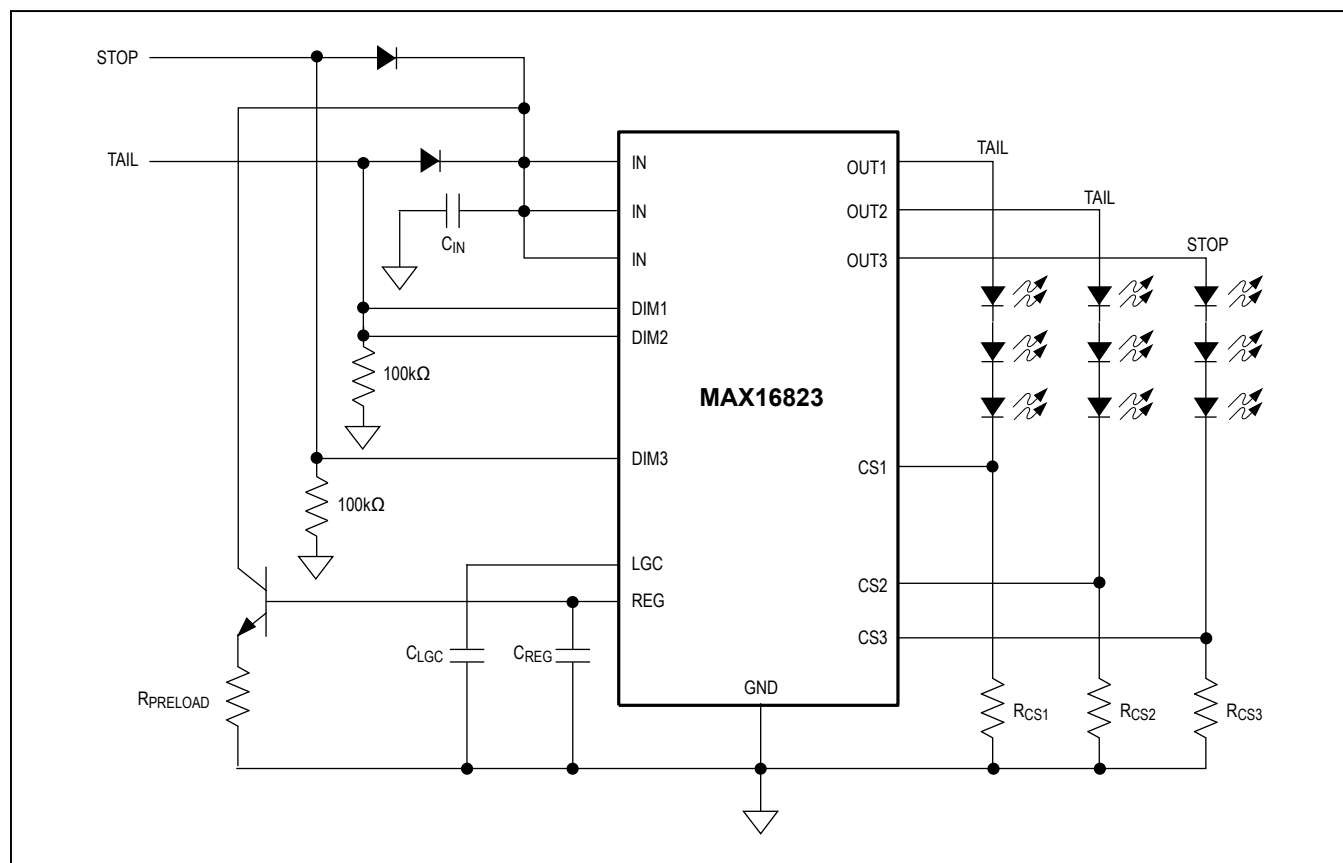


Figure 6. Preload Current Setting

Chip Information

PROCESS: BICMOS-DMOS

Package Information

For the latest package outline information and land patterns (footprints), go to www.maximintegrated.com/packages. Note that a "+", "#", or "-" in the package code indicates RoHS status only. Package drawings may show a different suffix character, but the drawing pertains to the package regardless of RoHS status.

PACKAGE TYPE	PACKAGE CODE	OUTLINE NO.	LAND PATTERN NO.
16 TQFN-EP	T1655+2	21-0140	90-0072
16 TSSOP	U16E+3	21-0108	90-0120

Ordering Information

PART	TEMP RANGE	PIN-PACKAGE
MAX16823ATE+	-40°C to +125°C	16 TQFN-EP*
MAX16823ATE/V+	-40°C to +125°C	16 TQFN-EP*
MAX16823AUE+	-40°C to +125°C	16 TSSOP-EP*
MAX16823AUE/V+	-40°C to +125°C	16 TSSOP-EP*

+Denotes a lead(Pb)-free/RoHS-compliant package.

*EP = Exposed pad.

/V denotes an automotive qualified part.

Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	1/07	Initial release	—
1	3/07	Released TQFN package	1
2	10/08	Updated <i>General Description</i> , <i>Features</i> , EC table, and <i>Detailed Description</i>	1, 2, 6
3	9/09	Added automotive packages	1
4	8/15	Updated <i>LEDGOOD</i> and <i>Package Information</i> sections	6, 11
5	6/17	Changed package code for TQFN in <i>Package Information</i> table from T1655+3 to T1655+2	11

For pricing, delivery, and ordering information, please contact Maxim Direct at 1-888-629-4642, or visit Maxim Integrated's website at www.maximintegrated.com.

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